



Vincotech

# 30-EP12NIA600H702-PM00F85T

datasheet

flowNPC E3BP

1200 V / 600 A

## Topology features

- Low side Kelvin Emitter for improved switching performance
- Neutral Point Clamped Topology (I-Type)
- Split topology
- Temperature sensor

## Component features

- High speed switching
- Low collector emitter saturation voltage
- Low turn-off losses
- Optimized for hard switching topologies
- Positive temperature coefficient

## Housing features

- Base isolation: Al<sub>2</sub>O<sub>3</sub>
- Cu baseplate
- Convex shaped baseplate for superior thermal contact
- CTI600 housing material
- Baseplate with rough surface
- Press-fit pin
- Reliable cold welding connection
- Thermo-mechanical push-and-pull force relief

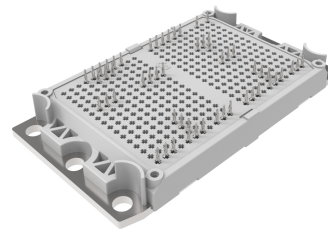
## Target applications

- Solar Inverters

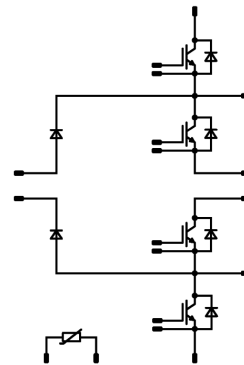
## Types

- 30-EP12NIA600H702-PM00F85T

## flow E3BP 12 mm housing



## Schematic





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**30-EP12NIA600H702-PM00F85T**  
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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
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### Buck Switch

Collector-emitter voltage	$V_{CES}$		1200	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	375	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	1800	A
Turn off safe operating area		$T_j = 150\text{ °C}$ , $V_{CE} = 1200\text{ V}$	1800	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	708	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Maximum junction temperature	$T_{jmax}$		175	°C

### Buck Diode

Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	240	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	1200	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	470	W
Maximum junction temperature	$T_{jmax}$		175	°C

### Boost Switch

Collector-emitter voltage	$V_{CES}$		1200	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	298	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	800	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	551	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$	$V_{GE} = 15\text{ V}$ , $V_{CC} = 800\text{ V}$ $T_j = 150\text{ °C}$	9,5	$\mu s$
Maximum junction temperature	$T_{jmax}$		175	°C



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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Boost Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	110	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	600	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	196	W
Maximum junction temperature	$T_{jmax}$		175	°C

## Boost Sw. Inv. Diode

Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	110	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	600	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	196	W
Maximum junction temperature	$T_{jmax}$		175	°C

## Module Properties

### Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	°C

### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage* $t_p = 2\text{ s}$	6800	V
Creepage distance			>12,7	mm
Clearance			>12,7	mm
Comparative Tracking Index	CTI		≥ 600	

\*100 % tested in production



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

## Buck Switch

### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0096	25	4,7	5,5	6,2	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		600	25 125 150		1,84 2,12 2,2	2,15 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	1200		25			32	µA
Gate-emitter leakage current	$I_{GES}$		20	0		25			800	nA
Internal gate resistance	$r_g$							None		Ω
Input capacitance	$C_{ies}$	$f = 100 \text{ kHz}$	0	25		25		76800		pF
Output capacitance	$C_{oes}$							1472		pF
Reverse transfer capacitance	$C_{res}$							432		pF
Gate charge	$Q_g$	$V_{CC} = 960 \text{ V}$	0/15		600	25		4400		nC

### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 5,2 \text{ W/mK}$ (PTM)						0,13		K/W
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### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 2 \text{ } \Omega$ $R_{goff} = 2 \text{ } \Omega$	$\pm 15$	600	600	25 125 150		434,93 435,69 440,71		ns
Rise time	$t_r$					25 125 150		38,15 38,05 37,94		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		345,89 384,06 395,75		ns
Fall time	$t_f$					25 125 150		32,21 61,55 67,3		ns
Turn-on energy (per pulse)	$E_{on}$	$Q_{tFWD} = 9,45 \text{ } \mu\text{C}$ $Q_{tFWD} = 27,62 \text{ } \mu\text{C}$ $Q_{tFWD} = 30,85 \text{ } \mu\text{C}$				25 125 150		27,13 29,4 29,86		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125 150		16,78 33,3 38,27		mWs





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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

## Buck Diode

### Static

Forward voltage	$V_F$				400	25 125 150		2,86 2,62 2,52	3 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 1200$ V				25			32	μA

### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,2		K/W
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### Dynamic

Peak recovery current	$I_{RM}$	$di/dt=15588$ A/μs $di/dt=16616$ A/μs $di/dt=18557$ A/μs	$\pm 15$	600	600	25 125 150		362,1 545,6 577,7		A
Reverse recovery time	$t_{rr}$					25 125 150		50,69 150,32 160,7		ns
Recovered charge	$Q_r$					25 125 150		9,45 27,62 30,85		μC
Reverse recovered energy	$E_{rec}$					25 125 150		4,2 13 14,39		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		22984,2 20327,3 19077,38		A/μs



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Boost Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$			10	0,04	25	5,4	6	6,6	V
Collector-emitter saturation voltage	$V_{CEsat}$		15		400	25 125 150		1,74 2,01 2,08	1,85 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	1200		25			200	µA
Gate-emitter leakage current	$I_{GES}$		20	0		25			1000	nA
Internal gate resistance	$r_g$							1		Ω
Input capacitance	$C_{ies}$	0	10		25			74000		pF
Output capacitance	$C_{oes}$							2200		pF
Reverse transfer capacitance	$C_{res}$							840		pF
Gate charge	$Q_g$	$V_{CC} = 600$ V	0/15		400	25		2400		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,17		K/W
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 2$ Ω $R_{goff} = 2$ Ω	±15	600	400	25 125 150		428,28 435,05 436,05		ns
Rise time	$t_r$					25 125 150		103,05 115,9 120,93		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		283,52 320,34 331,2		ns
Fall time	$t_f$					25 125 150		67,91 89,59 96,53		ns
Turn-on energy (per pulse)	$E_{on}$	$Q_{tfwd} = 5,97$ µC $Q_{tfwd} = 13,28$ µC $Q_{tfwd} = 15,74$ µC				25 125 150		34,02 44,84 47,91		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125 150		30,36 41,66 44,65		mWs



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]		Min	Typ	Max	

### Boost Diode

#### Static

Forward voltage	$V_F$				200	25 125 150		2,72 2,42 2,34	3 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 1200$ V				25			8	µA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,48		K/W
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#### Dynamic

Peak recovery current	$I_{RM}$	$di/dt=3256$ A/µs $di/dt=3499$ A/µs $di/dt=2911$ A/µs	$\pm 15$	600	400	25 125 150		96,99 113,85 119,02		A
Reverse recovery time	$t_{rr}$					25 125 150		157,94 255,7 291,62		ns
Recovered charge	$Q_r$					25 125 150		5,97 13,28 15,74		µC
Reverse recovered energy	$E_{rec}$					25 125 150		1,11 2,95 3,62		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		3387,9 943,29 472,79		A/µs



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]		Min	Typ	Max	

Boost Sw. Inv. Diode

Static

Forward voltage	$V_F$				200	25 125 150		2,72 2,42 2,34	3 <sup>(1)</sup>		V
Reverse leakage current	$I_R$	$V_i = 1200$ V				25			8		µA

Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,48			K/W
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Thermistor

Static

Rated resistance	$R$					25		22			kΩ
Deviation of R100	$\Delta_{R/R}$	$R_{100} = 1484$ Ω				100	-5		5		%
Power dissipation	$P$					25		130			mW
Power dissipation constant	$d$					25		1,5			mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962			K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000			K
Vincotech Thermistor Reference									I		

<sup>(1)</sup> Value at chip level

<sup>(2)</sup> Only valid with pre-applied Vincotech thermal interface material.



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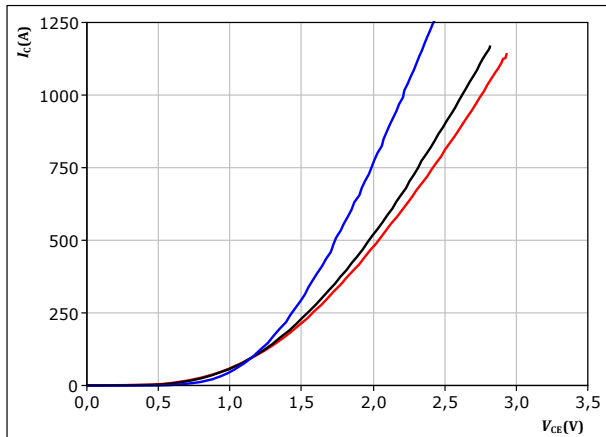
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## Buck Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

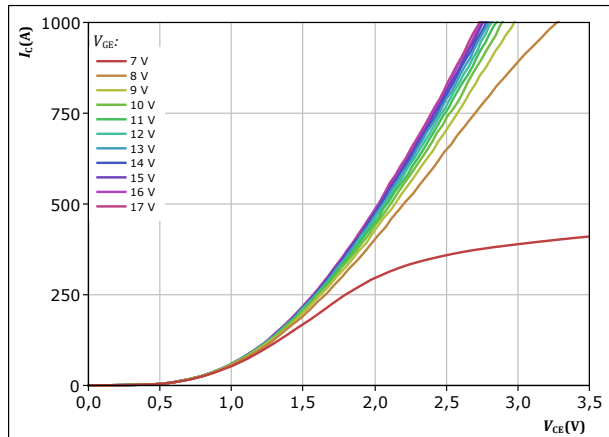


$t_p = 250 \mu s$   
 $V_{GE} = 15 V$   
 $T_j:$  25 °C, 125 °C, 150 °C

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

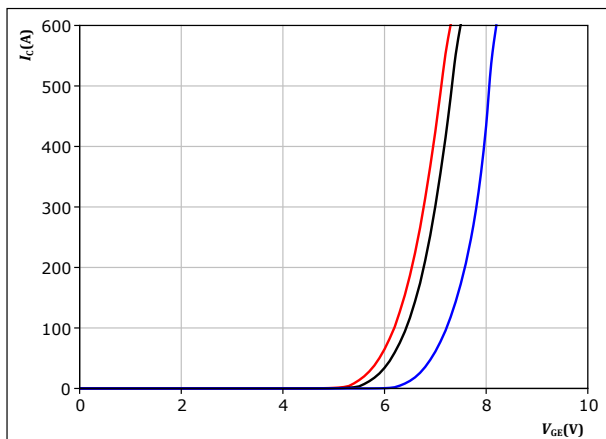


$t_p = 250 \mu s$   
 $T_j = 150 ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

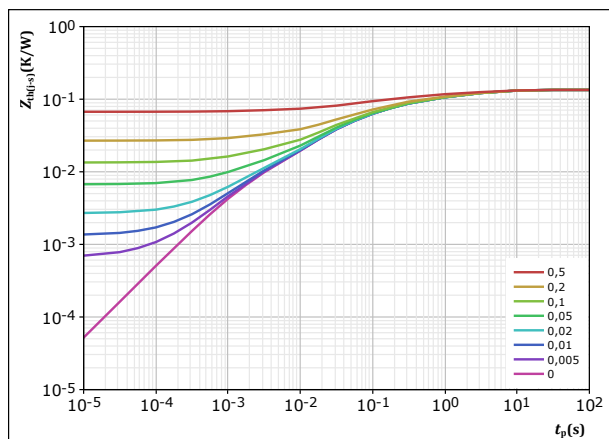


$t_p = 250 \mu s$   
 $V_{CE} = 10 V$   
 $T_j:$  25 °C, 125 °C, 150 °C

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0,134 K/W$   
IGBT thermal model values  

$R (K/W)$	$\tau (s)$
1,79E-02	5,14E+00
2,60E-02	1,43E+00
4,74E-02	1,95E-01
3,68E-02	2,86E-02
6,13E-03	1,70E-03



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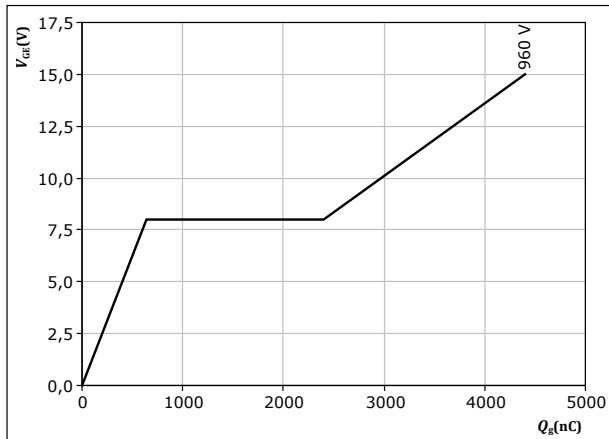
## Buck Switch Characteristics

figure 5.

IGBT

Gate voltage vs gate charge

$$V_{GE} = f(Q_g)$$



$I_C = 600$  A  
 $T_j = 25$  °C



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## Buck Diode Characteristics

figure 6.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

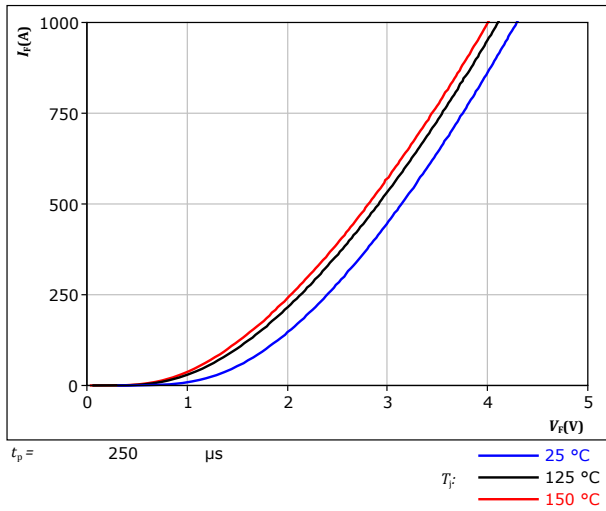
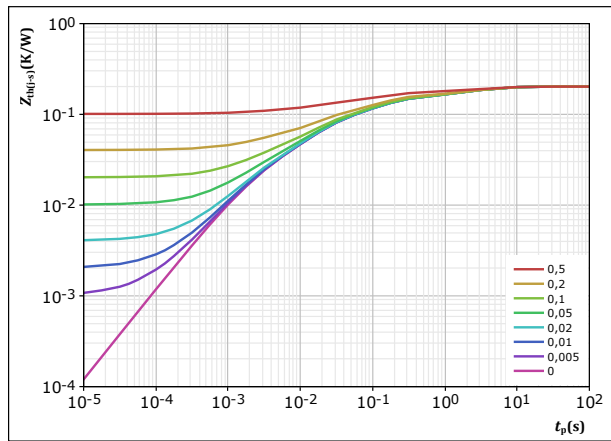


figure 7.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	$t_p / T$	
$R_{th(j-s)} =$	0,202	K/W
FWD thermal model values		
$R$ (K/W)	$\tau$ (s)	
1,01E-02	6,63E+00	
4,38E-02	2,17E+00	
7,49E-02	1,27E-01	
5,75E-02	1,74E-02	
1,59E-02	1,98E-03	



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## Boost Switch Characteristics

figure 8. IGBT

Typical output characteristics

$$I_c = f(V_{CE})$$

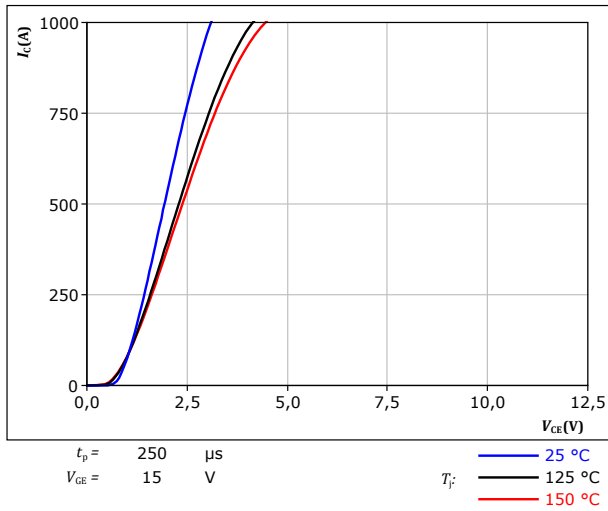


figure 9. IGBT

Typical output characteristics

$$I_c = f(V_{CE})$$

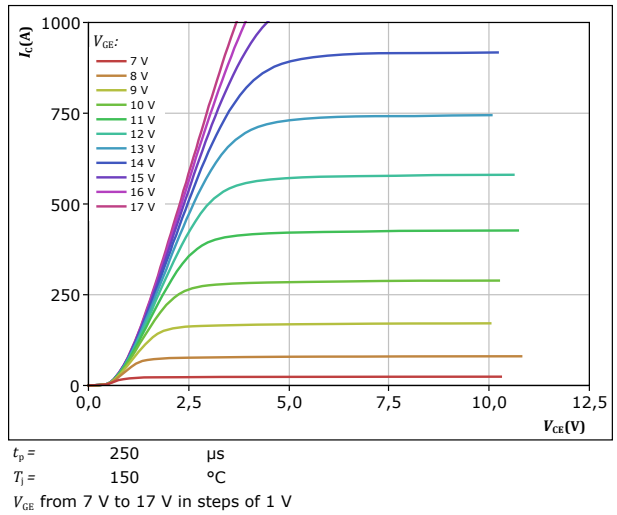


figure 10. IGBT

Typical transfer characteristics

$$I_c = f(V_{GE})$$

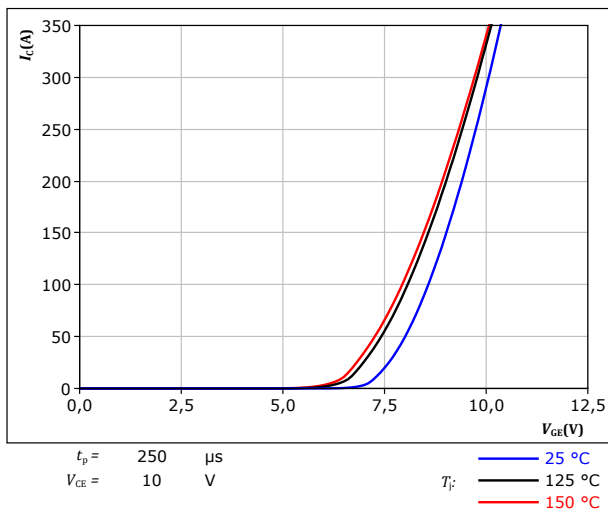
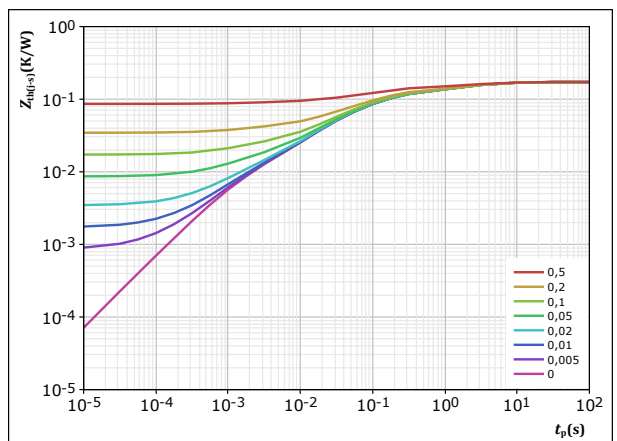


figure 11. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



IGBT thermal model values	
$R$ (K/W)	$\tau$ (s)
2,18E-02	5,31E+00
3,84E-02	1,27E+00
7,42E-02	1,08E-01
3,10E-02	2,16E-02
6,97E-03	1,39E-03





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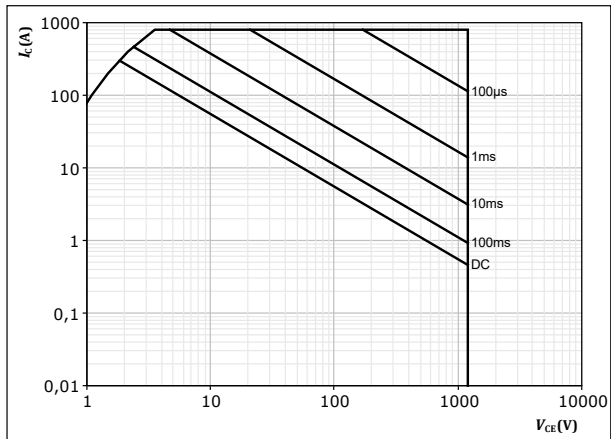
## Boost Switch Characteristics

figure 12.

IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$  single pulse

$T_s = 80$  °C

$V_{GE} = 15$  V

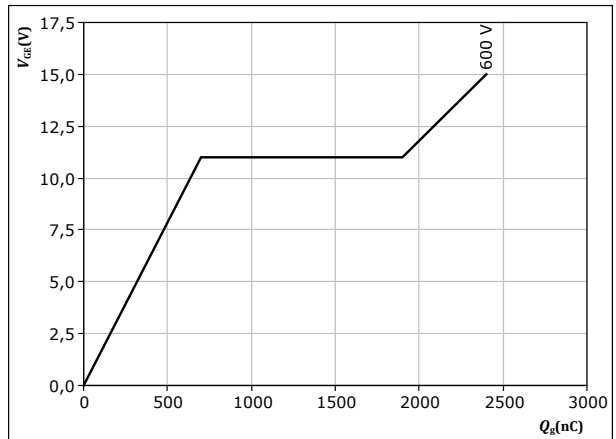
$T_j = T_{jmax}$

figure 13.

IGBT

Gate voltage vs gate charge

$$V_{GE} = f(Q_g)$$



$I_C = 400$  A

$T_j = 25$  °C



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## Boost Diode Characteristics

figure 14.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

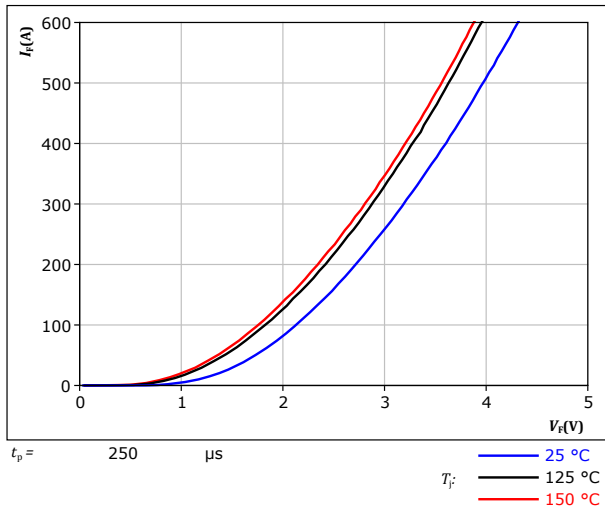
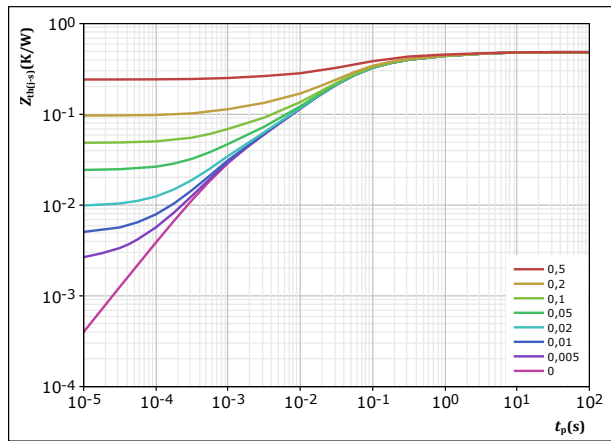


figure 15.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	$t_p / T$
$R_{th(j-s)} =$	0,484 K/W
FWD thermal model values	
$R$ (K/W)	$\tau$ (s)
4,96E-02	3,28E+00
7,95E-02	4,30E-01
2,38E-01	6,16E-02
8,86E-02	1,21E-02
2,86E-02	9,94E-04



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## Boost Sw. Inv. Diode Characteristics

figure 16.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

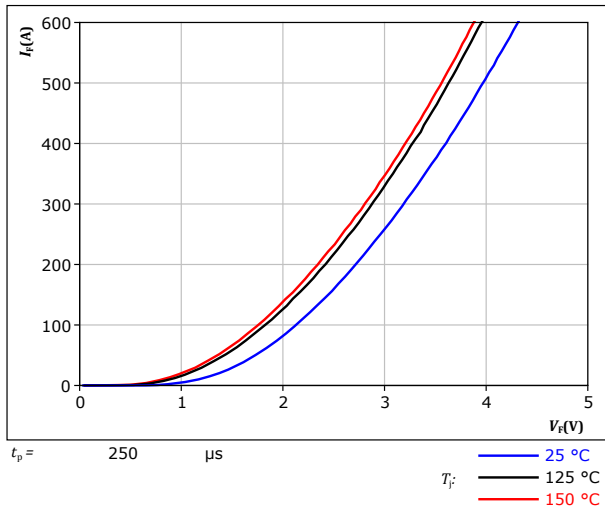
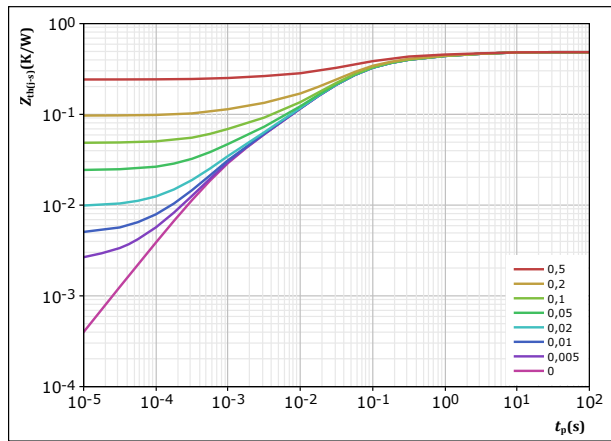


figure 17.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$





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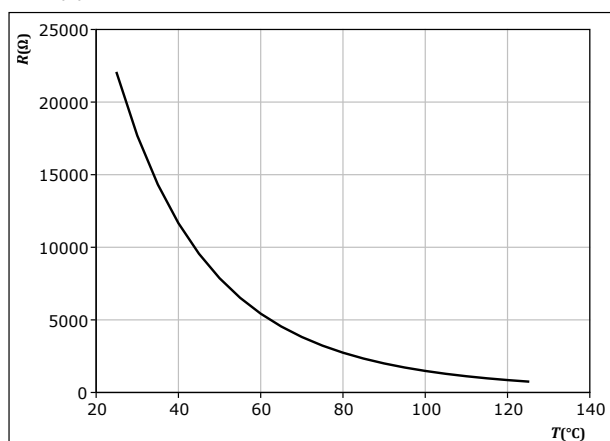
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## Thermistor Characteristics

**figure 18.** Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





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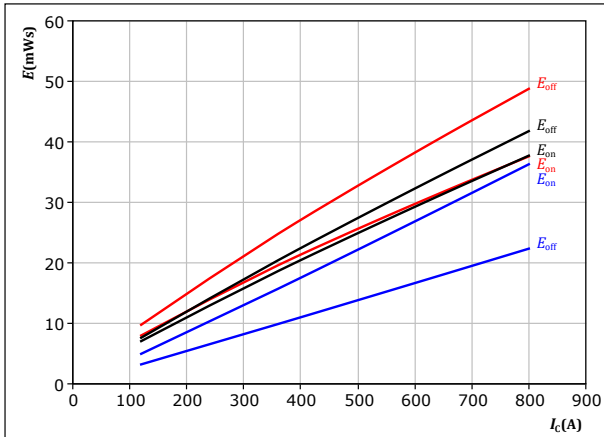
## Buck Switching Characteristics

figure 19.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \text{ } \Omega$   
 $R_{goff} = 2 \text{ } \Omega$

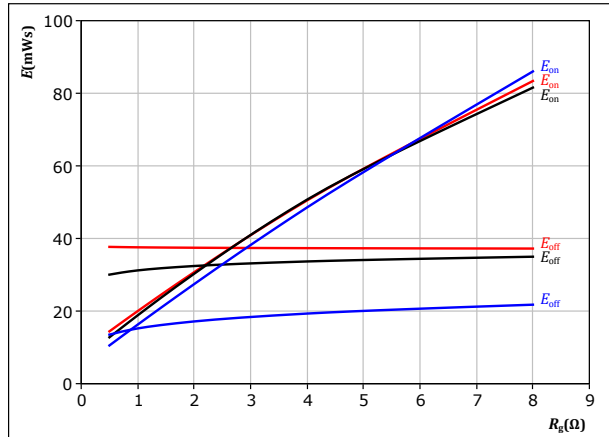
$T_j$ :  $25 \text{ } ^\circ\text{C}$  (blue)  
 $125 \text{ } ^\circ\text{C}$  (black)  
 $150 \text{ } ^\circ\text{C}$  (red)

figure 20.

IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 600 \text{ A}$

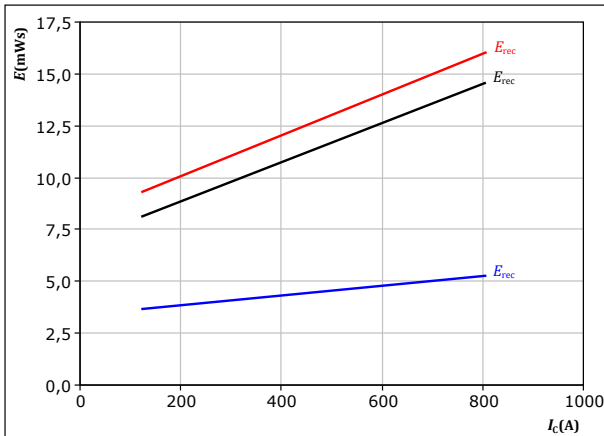
$T_j$ :  $25 \text{ } ^\circ\text{C}$  (blue)  
 $125 \text{ } ^\circ\text{C}$  (black)  
 $150 \text{ } ^\circ\text{C}$  (red)

figure 21.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \text{ } \Omega$

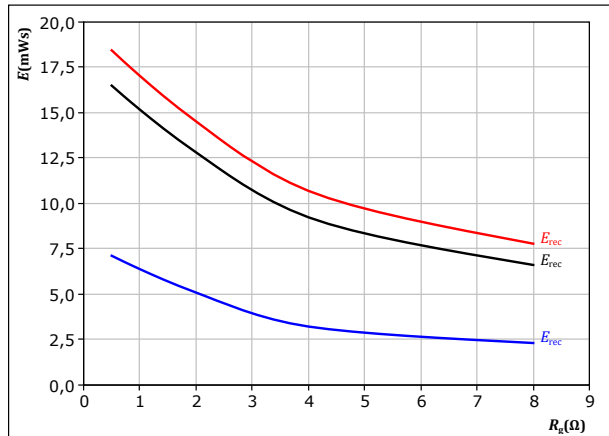
$T_j$ :  $25 \text{ } ^\circ\text{C}$  (blue)  
 $125 \text{ } ^\circ\text{C}$  (black)  
 $150 \text{ } ^\circ\text{C}$  (red)

figure 22.

FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 600 \text{ A}$

$T_j$ :  $25 \text{ } ^\circ\text{C}$  (blue)  
 $125 \text{ } ^\circ\text{C}$  (black)  
 $150 \text{ } ^\circ\text{C}$  (red)



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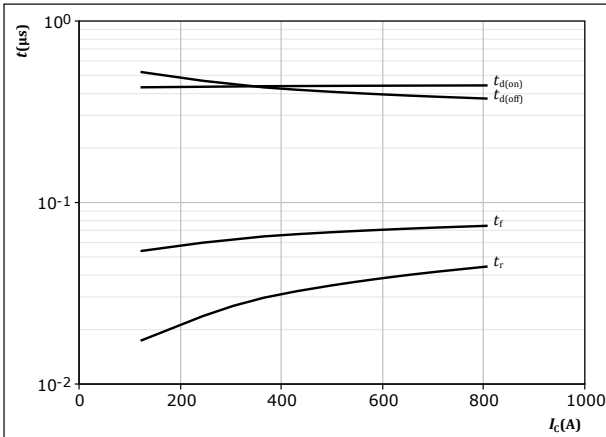
30-EP12NIA600H702-PM00F85T  
datasheet

## Buck Switching Characteristics

figure 23.

IGBT

Typical switching times as a function of collector current  
 $t = f(I_C)$



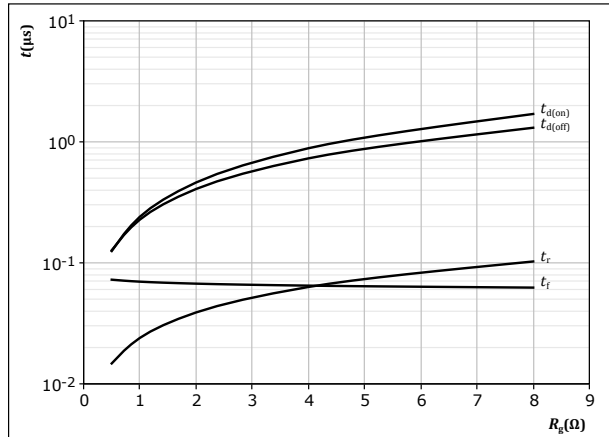
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 2$  Ω  
 $R_{goff} = 2$  Ω

figure 24.

IGBT

Typical switching times as a function of IGBT turn on gate resistor  
 $t = f(R_g)$



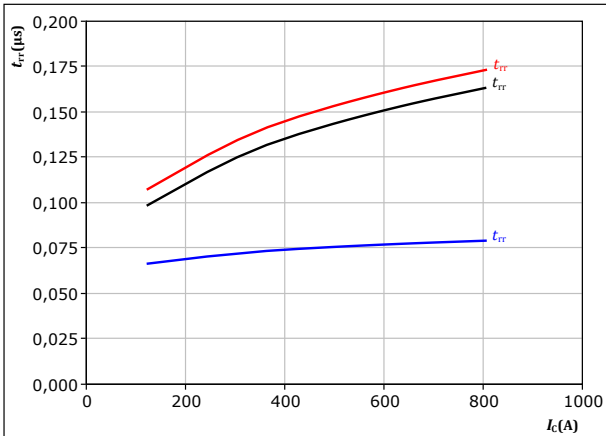
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 600$  A

figure 25.

FWD

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_C)$



With an inductive load at

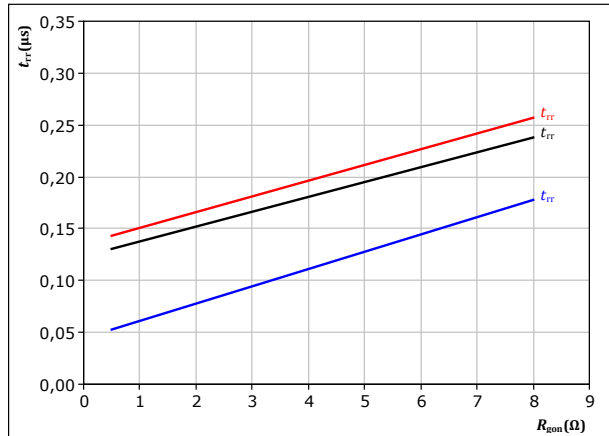
$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 2$  Ω

$T_j$ : — 25 °C  
— 125 °C  
— 150 °C

figure 26.

FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor  
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 600$  A

$T_j$ : — 25 °C  
— 125 °C  
— 150 °C



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datasheet

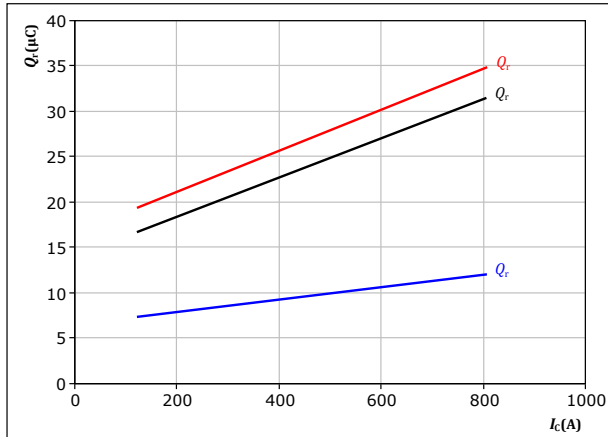
## Buck Switching Characteristics

figure 27.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 2$   $\Omega$

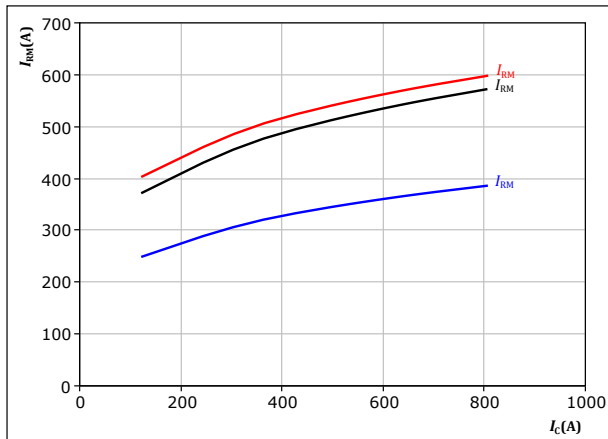
$T_j$ : 25 °C  
125 °C  
150 °C

figure 29.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 2$   $\Omega$

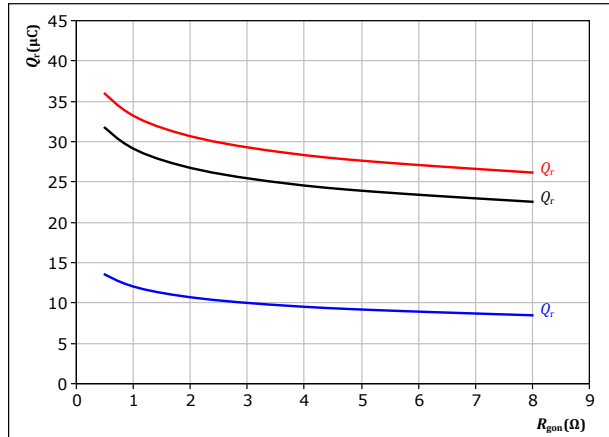
$T_j$ : 25 °C  
125 °C  
150 °C

figure 28.

FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 600$  A

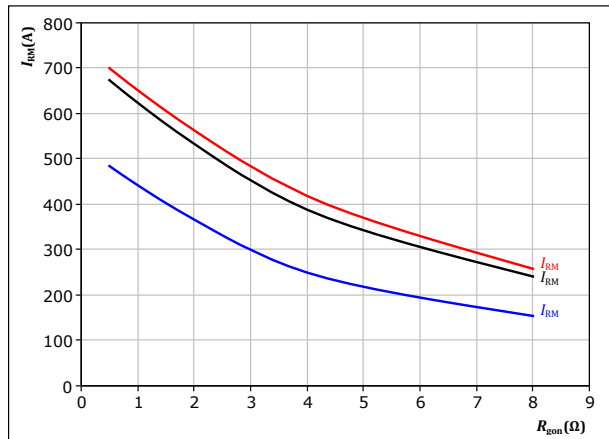
$T_j$ : 25 °C  
125 °C  
150 °C

figure 30.

FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 600$  A

$T_j$ : 25 °C  
125 °C  
150 °C



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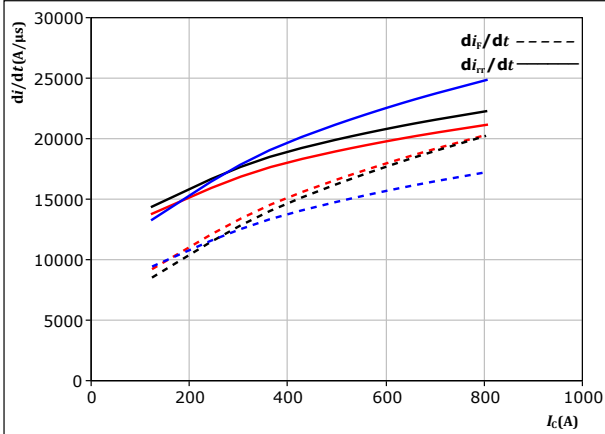
# 30-EP12NIA600H702-PM00F85T

datasheet

## Buck Switching Characteristics

figure 31. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_r/dt = f(I_C)$



With an inductive load at

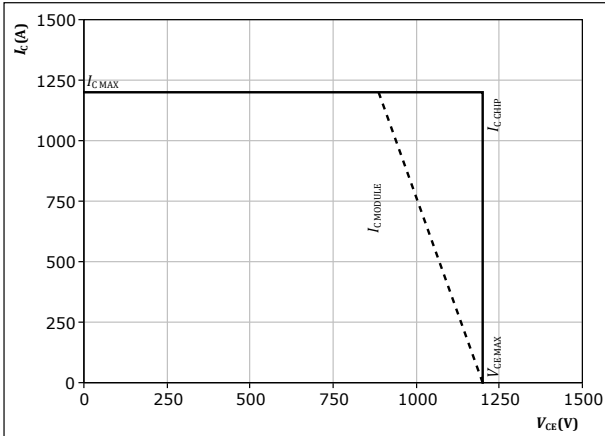
$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 2$   $\Omega$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 32. FWD

Reverse bias safe operating area

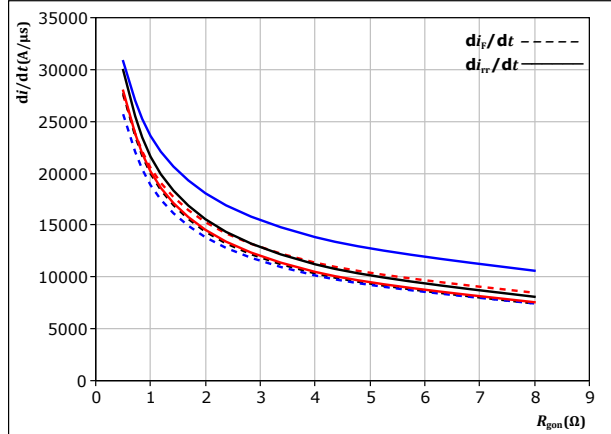
$I_C = f(V_{CE})$



At  $T_j = 150$  °C  
 $R_{gon} = 2$   $\Omega$   
 $R_{goff} = 2$   $\Omega$

figure 33. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor  
 $di_f/dt, di_r/dt = f(R_{gon})$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 600$  A

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C





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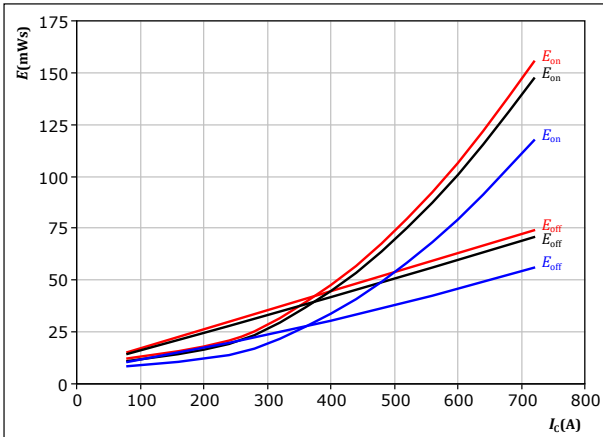
## Boost Switching Characteristics

figure 34.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \text{ } \Omega$   
 $R_{goff} = 2 \text{ } \Omega$

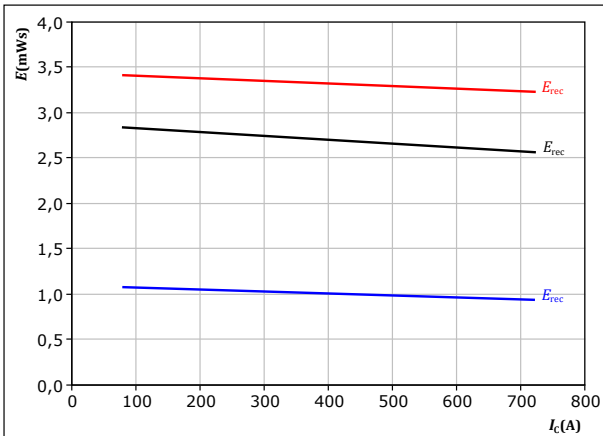
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 36.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \text{ } \Omega$

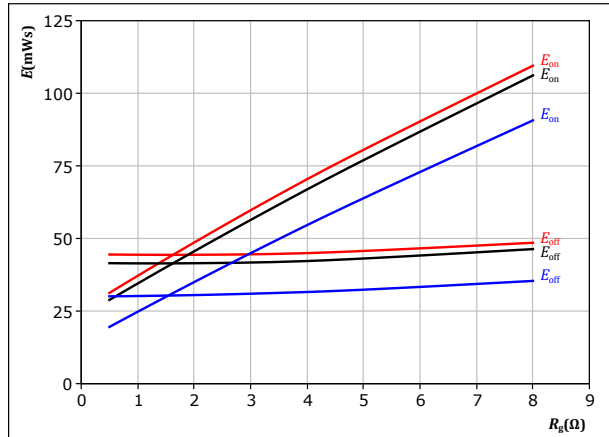
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 35.

IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 400 \text{ A}$

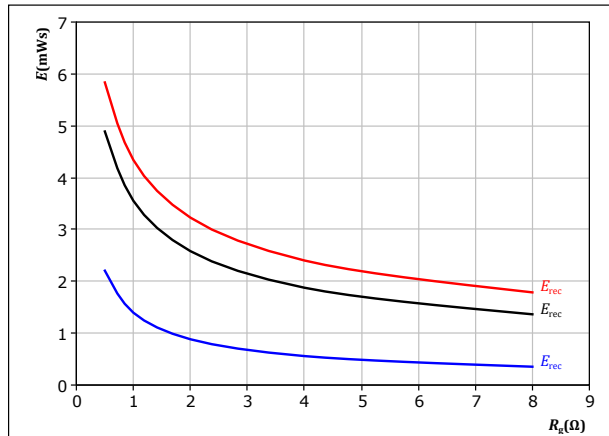
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 37.

FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 400 \text{ A}$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C



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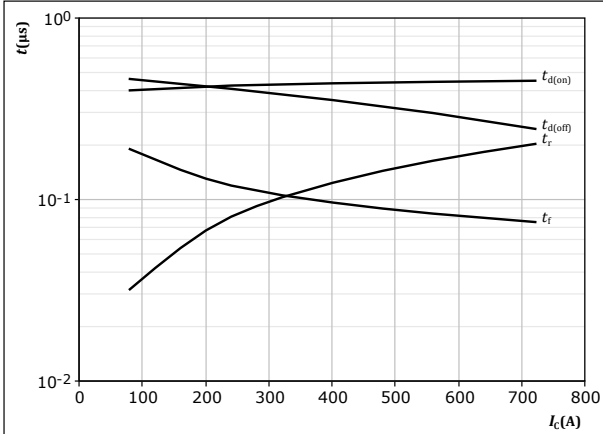
# 30-EP12NIA600H702-PM00F85T datasheet

## Boost Switching Characteristics

figure 38.

IGBT

Typical switching times as a function of collector current  
 $t = f(I_c)$



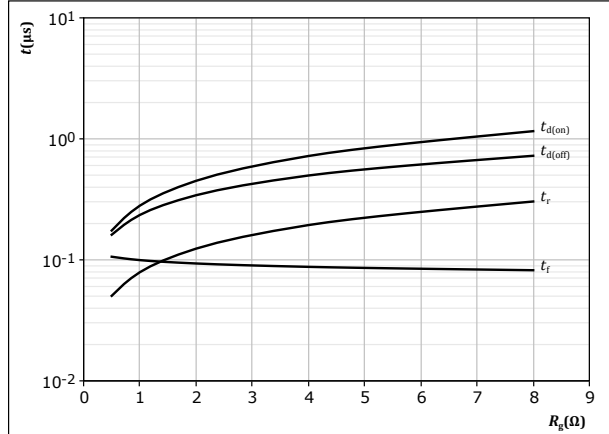
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 2$  Ω  
 $R_{goff} = 2$  Ω

figure 39.

IGBT

Typical switching times as a function of IGBT turn on gate resistor  
 $t = f(R_g)$



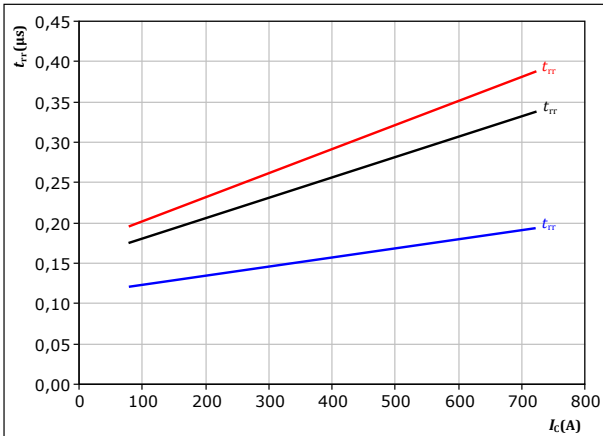
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 400$  A

figure 40.

FWD

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_c)$



With an inductive load at

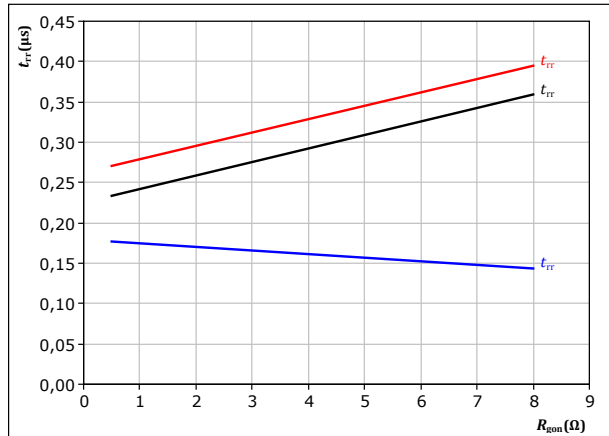
$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 2$  Ω

$T_j$ : — 25 °C  
— 125 °C  
— 150 °C

figure 41.

FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor  
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 400$  A

$T_j$ : — 25 °C  
— 125 °C  
— 150 °C



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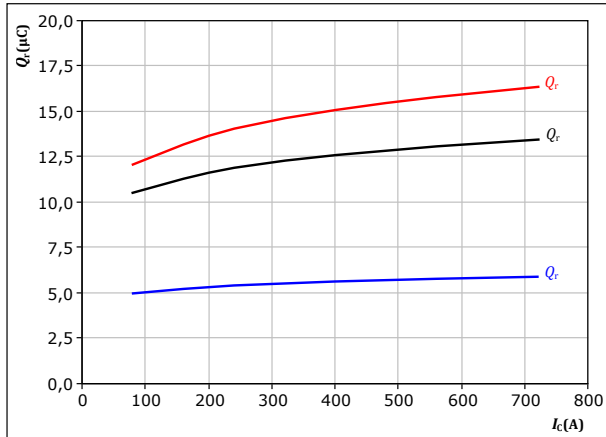
datasheet

## Boost Switching Characteristics

figure 42. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



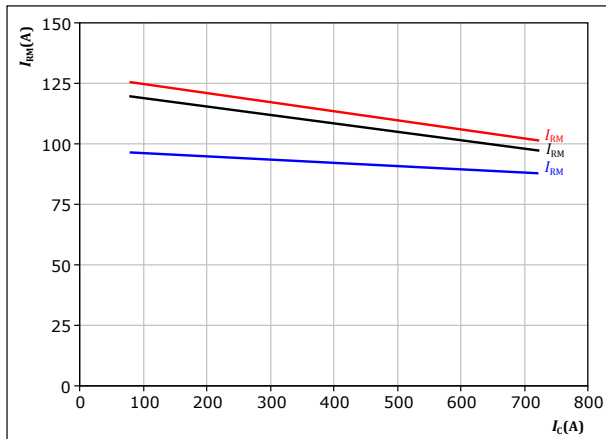
With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 2$  Ω  
 $T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 44. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



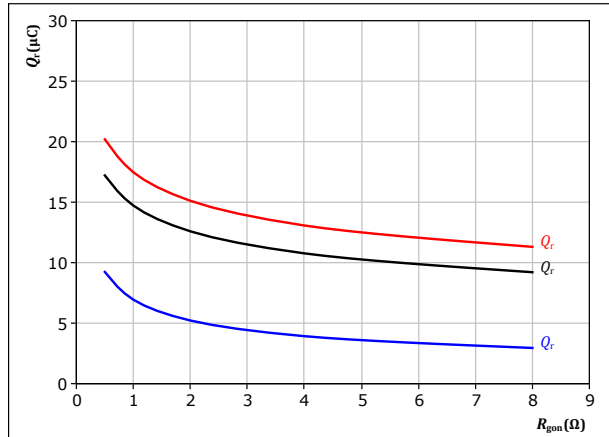
With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 2$  Ω  
 $T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 43. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



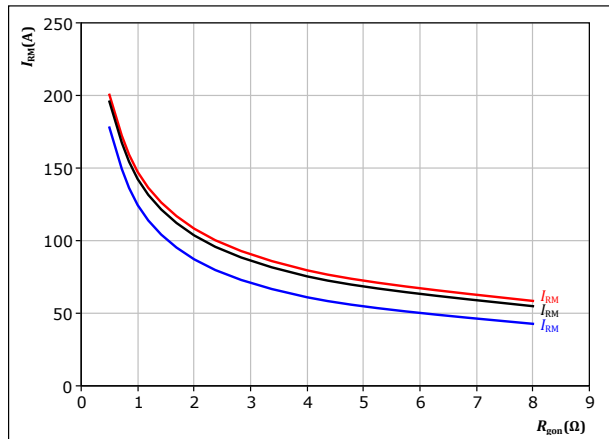
With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 400$  A  
 $T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 45. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 400$  A  
 $T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)



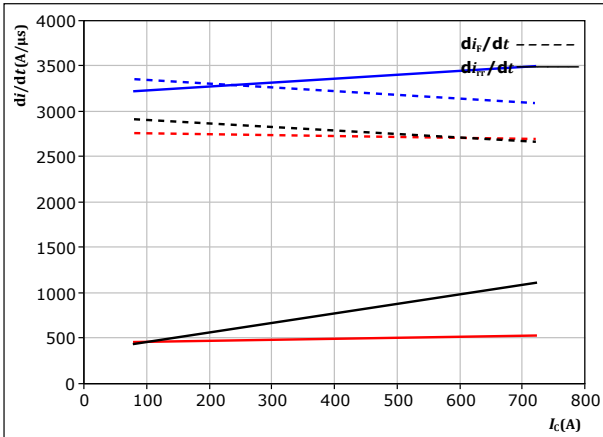
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**30-EP12NIA600H702-PM00F85T**  
datasheet

## Boost Switching Characteristics

**figure 46.** FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_r/dt = f(I_C)$



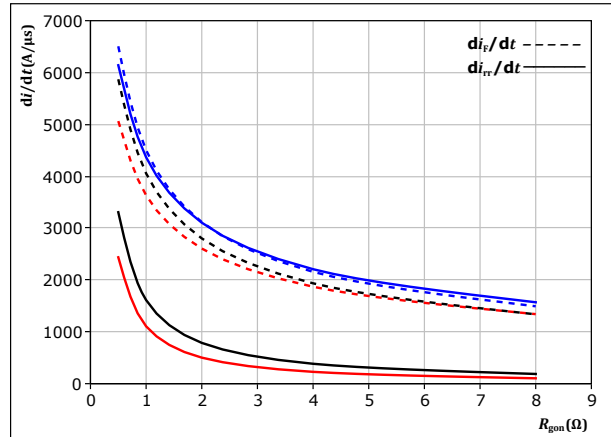
With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \text{ } \Omega$

$T_j:$  — 25 °C  
— 125 °C  
— 150 °C

**figure 47.** FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor  
 $di_f/dt, di_r/dt = f(R_{gon})$



With an inductive load at

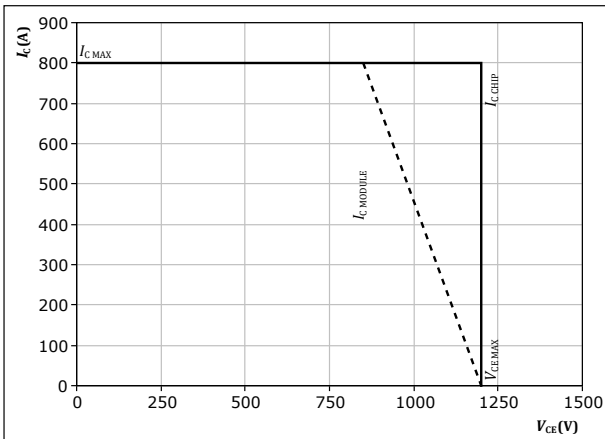
$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 400 \text{ A}$

$T_j:$  — 25 °C  
— 125 °C  
— 150 °C

**figure 48.** IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At  $T_j = 150 \text{ } ^\circ\text{C}$   
 $R_{gon} = 2 \text{ } \Omega$   
 $R_{goff} = 2 \text{ } \Omega$

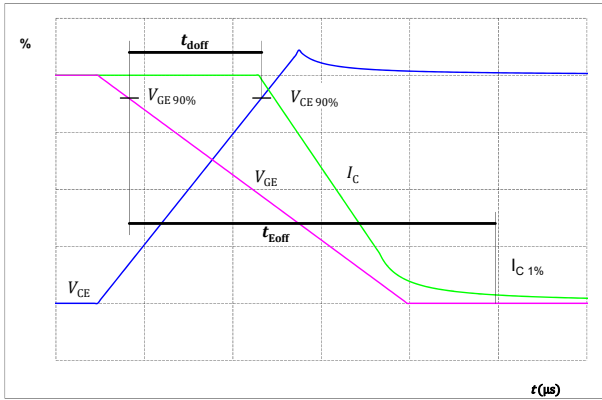


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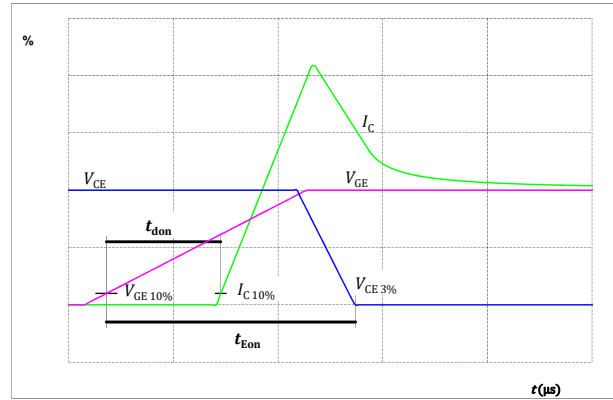
# 30-EP12NIA600H702-PM00F85T datasheet

## Switching Definitions

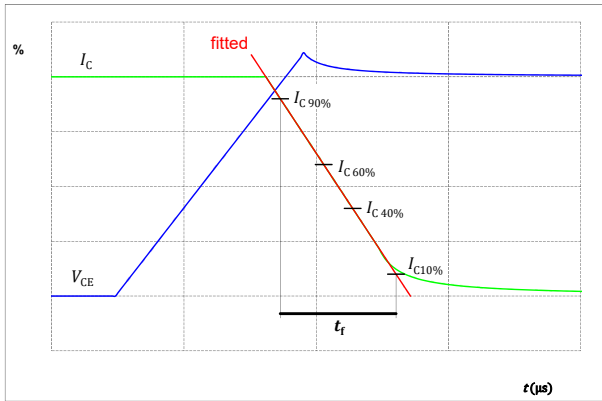
**figure 49.** IGBT  
Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



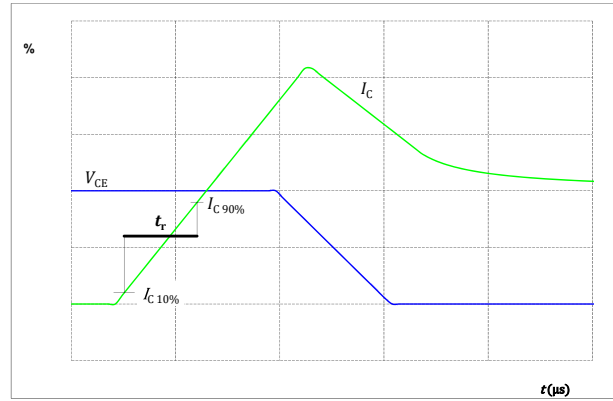
**figure 50.** IGBT  
Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



**figure 51.** IGBT  
Turn-off Switching Waveforms & definition of  $t_f$



**figure 52.** IGBT  
Turn-on Switching Waveforms & definition of  $t_r$





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## Switching Definitions

figure 53.

FWD

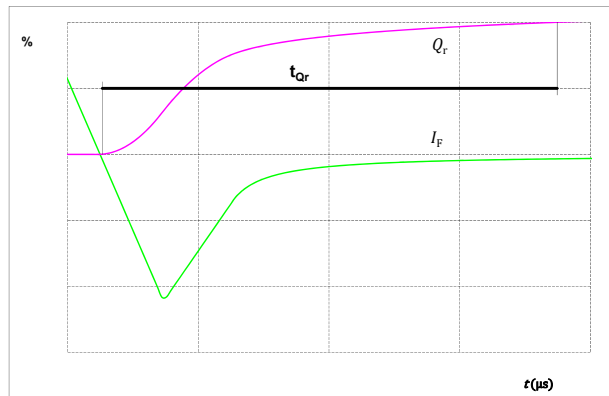
Turn-off Switching Waveforms & definition of  $t_{rr}$



figure 54.

FWD

Turn-on Switching Waveforms & definition of  $t_{Qr}$  ( $t_{Qr}$  = integrating time for  $Q_r$ )





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datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	30-EP12NIA600H702-PM00F85T
With thermal paste (5,2 W/mK, PTM6000HV)	30-EP12NIA600H702-PM00F85T-/7/

Marking						
	Text	Name	Date code	UL & VIN	Lot	Serial
		NN-NNNNNNNNNNNNNN- TTTTTVV	WWYY	UL VIN	LLLL	SSSS
	Datamatrix	Type&Ver	Lot number	Serial	Date code	
		TTTTTVV	LLLL	SSSS	WWYY	

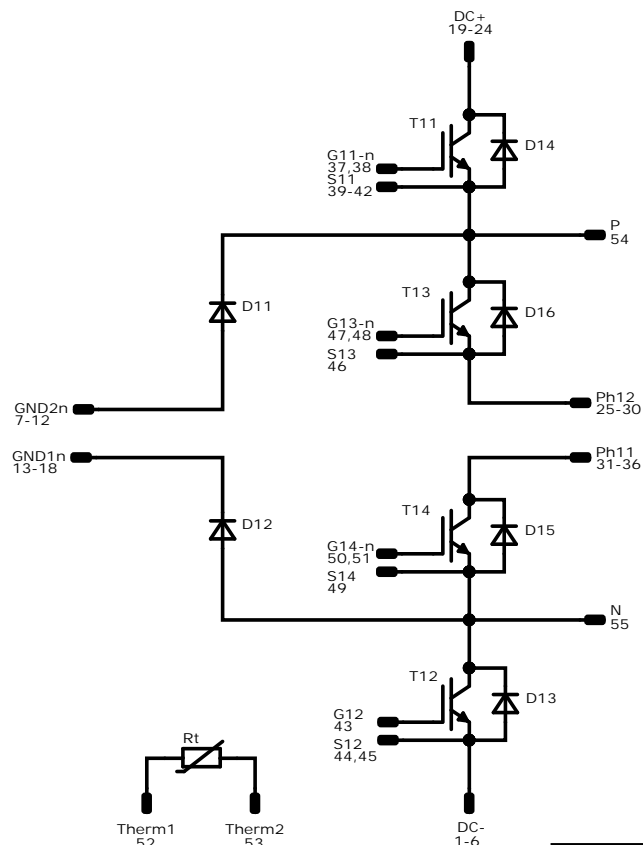
Outline								
Pin table [mm]								
Pin	X	Y	Function	29	22,4	48	Ph12	
1	52,96	0	DC-	30	25,6	48	Ph12	
2	56,16	0	DC-	31	40,16	48	Ph11	
3	59,36	0	DC-	32	43,36	48	Ph11	
4	56,16	3,2	DC-	33	46,56	48	Ph11	
5	56,16	6,4	DC-	34	49,76	48	Ph11	
6	56,16	9,6	DC-	35	52,96	48	Ph11	
7	0	0	GND21	36	56,16	48	Ph11	
8	3,2	0	GND21	37	6,4	32	G11-1	
9	6,4	0	GND21	38	25,6	32	G11-2	
10	25,6	0	GND22	39	3,2	32	S11	
11	28,8	0	GND22	40	9,6	32	S11	
12	32	0	GND22	41	22,4	32	S11	
13	40,16	0	GND12	42	28,8	32	S11	
14	43,36	0	GND12	43	56,16	22,4	G12	
15	46,56	0	GND12	44	52,96	22,4	S12	
16	65,76	0	GND11	45	59,36	22,4	S12	
17	68,96	0	GND11	46	16	44,8	S13	
18	72,16	0	GND11	47	12,8	44,8	G13-1	
19	12,8	0	DC+	48	19,2	44,8	G13-2	
20	16	0	DC+	49	56,16	35,2	S14	
21	19,2	0	DC+	50	52,96	35,2	G14-2	
22	16	3,2	DC+	51	59,36	35,2	G14-1	
23	16	6,4	DC+	52	65,76	48	Therm1	
24	16	9,6	DC+	53	72,16	48	Therm2	
25	9,6	48	Ph12	54	32	32	P	
26	12,8	48	Ph12	55	56,16	32	N	
27	16	48	Ph12					
28	19,2	48	Ph12					



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**Pinout**



**Identification**


ID	Component	Voltage	Current	Function	Comment
T11, T12	IGBT	1200 V	600 A	Buck Switch	Parallel devices with separate control. Values apply to complete device.
D11, D12	FWD	1200 V	400 A	Buck Diode	Parallel devices. Values apply to complete device.
T13, T14	IGBT	1200 V	400 A	Boost Switch	Parallel devices with separate control. Values apply to complete device.
D13, D14	FWD	1200 V	200 A	Boost Diode	Parallel devices. Values apply to complete device.
D16, D15	FWD	1200 V	200 A	Boost Sw. Inv. Diode	Parallel devices. Values apply to complete device.
Rt	Thermistor			Thermistor	





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datasheet

Packaging instruction				
Standard packaging quantity (SPQ) 24	>SPQ	Standard	<SPQ	Sample
Handling instruction				
Handling instructions for <i>flow</i> E3BP packages see vincotech.com website.				
Package data				
Package data for <i>flow</i> E3BP packages see vincotech.com website.				
Vincotech thermistor reference				
See Vincotech thermistor reference table at vincotech.com website.				
UL recognition and file number				
This device is UL 1557 recognized under E192116 up to a junction temperature under switching condition $T_{j,op}=175^{\circ}\text{C}$ and up to 4000VAC/1min isolation voltage. For more information see vincotech.com website.				

Document No.:	Date:	Modification:	Pages
30-EP12NIA600H702-PM00F85T-D3-14	10 Jul. 2025	Update Isolation Voltage	

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As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.